HEF4051B

8-channel analog multiplexer/demultiplexer

Rev. 12 — 25 March 2016 Product data sheet

1. General description

The HEF4051B is an 8-channel analog multiplexer/demultiplexer with three address inputs (S1 to S3), an active LOW enable input ($\overline{E}$), eight independent inputs/outputs (Y0 to Y7) and a common input/output (Z). The device contains eight bidirectional analog switches, each with one side connected to an independent input/output (Y0 to Y7) and the other side connected to a common input/output (Z). With $\overline{E}$ LOW, one of the eight switches is selected (low-impedance ON-state) by S1 to S3. With $\overline{E}$ HIGH, all switches are in the high-impedance OFF-state, independent of S1 to S3. If break before make is needed, then it is necessary to use the enable input.

V_{DD} and V_{SS} are the supply voltage connections for the digital control inputs (S1 to S3, and $\overline{E}$). The V_{DD} to V_{SS} range is 3 V to 15 V. The analog inputs/outputs (Y0 to Y7, and Z) can swing between V_{DD} as a positive limit and V_{EE} as a negative limit. $V_{DD} - V_{EE}$ may not exceed 15 V. Unused inputs must be connected to V_{DD}, V_{SS}, or another input. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to V_{SS} (typically ground). V_{EE} and V_{SS} are the supply voltage connections for the switches.

2. Features and benefits

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from −40 °C to +85 °C and −40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

3. Applications

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

nexperia

4. Ordering information

Table 1. Ordering information

All types operate from −40 °C to +125 °C.

Type number	Package		
	Name	Description	Version
HEF4051BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
HEF4051BTS	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
HEF4051BTT	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

5. Functional diagram

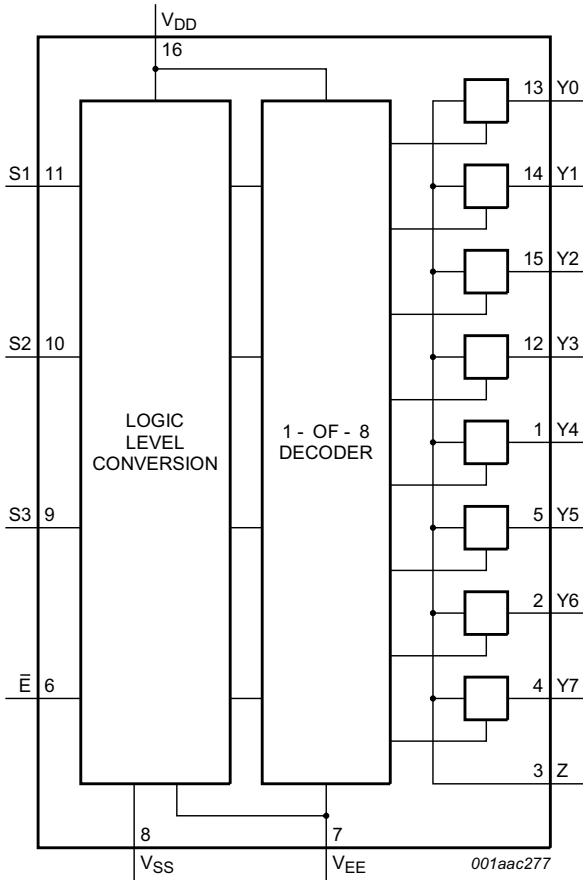


Fig 1. Functional diagram

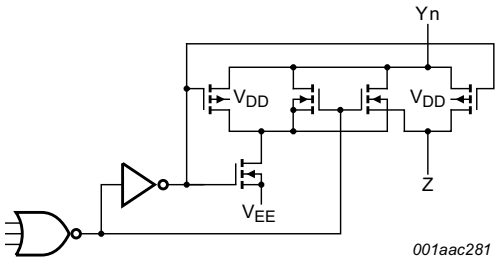


Fig 2. Schematic diagram (one switch)

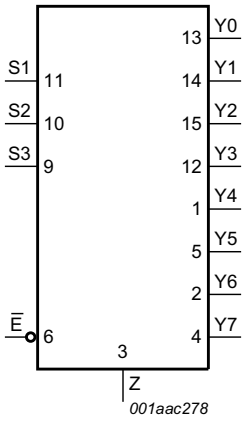


Fig 3. Logic symbol

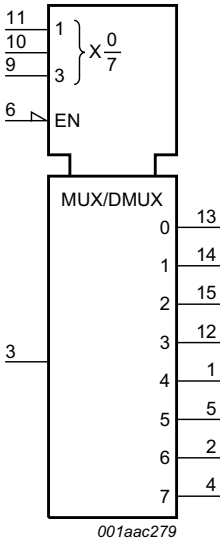


Fig 4. IEC logic symbol

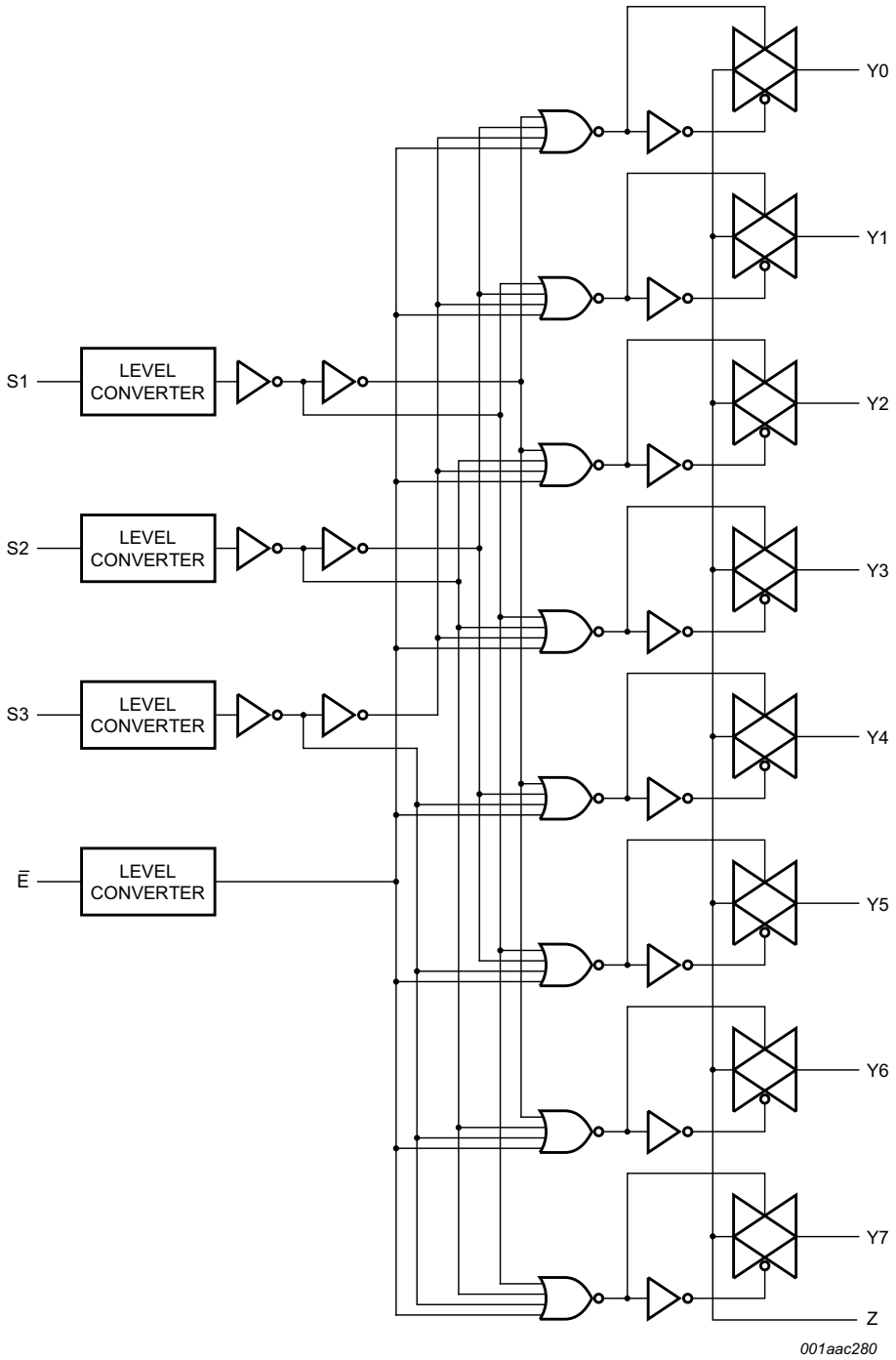


Fig 5. Logic diagram

6. Pinning information

6.1 Pinning

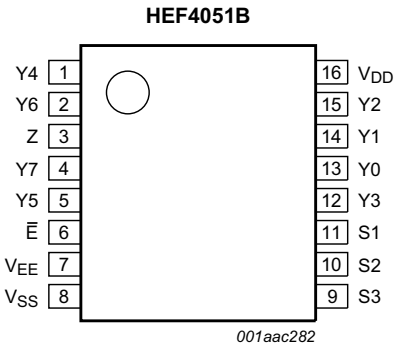


Fig 6. Pin configuration

6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
$\overline{E}$	6	enable input (active LOW)
V_{EE}	7	supply voltage
V_{SS}	8	ground supply voltage
S1, S2, S3	11, 10, 9	select input
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	13, 14, 15, 12, 1, 5, 2, 4	independent input or output
Z	3	common output or input
V_{DD}	16	supply voltage

7. Functional description

7.1 Function table

Table 3. Function table[1]

Input				Channel ON
$\overline{E}$	S3	S2	S1	
L	L	L	L	Y0 to Z
L	L	L	H	Y1 to Z
L	L	H	L	Y2 to Z
L	L	H	H	Y3 to Z
L	H	L	L	Y4 to Z
L	H	L	H	Y5 to Z
L	H	H	L	Y6 to Z
L	H	H	H	Y7 to Z
H	X	X	X	switches off

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to V_{SS} = 0 V (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		−0.5	+18	V
V_{EE}	supply voltage	referenced to V_{DD} [1]	−18	+0.5	V
I_{IK}	input clamping current	pins Sn and $\overline{E}$; $V_I < -0.5$ V or $V_I > V_{DD} + 0.5$ V	-	±10	mA
V_I	input voltage		−0.5	V_{DD} + 0.5	V
$I_{I/O}$	input/output current		-	±10	mA
I_{DD}	supply current		-	50	mA
T_{stg}	storage temperature		−65	+150	°C
T_{amb}	ambient temperature		−40	+125	°C
P_{tot}	total power dissipation	T_{amb} = −40 °C to +125 °C [2]			
		SO16 package	-	500	mW
		SSOP16 package	-	500	mW
		TSSOP16 package	-	500	mW
P	power dissipation	per output	-	100	mW

[1] To avoid drawing V_{DD} current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{DD} current will flow out of terminals Y, and in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V_{DD} or V_{EE}.

[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
For SSOP16 and TSSOP16 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DD}	supply voltage	see Figure 7	3	-	15	V
V_I	input voltage		0	-	V_{DD}	V
T_{amb}	ambient temperature	in free air	−40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{DD} = 5 V	-	-	3.75	µs/V
		V_{DD} = 10 V	-	-	0.5	µs/V
		V_{DD} = 15 V	-	-	0.08	µs/V

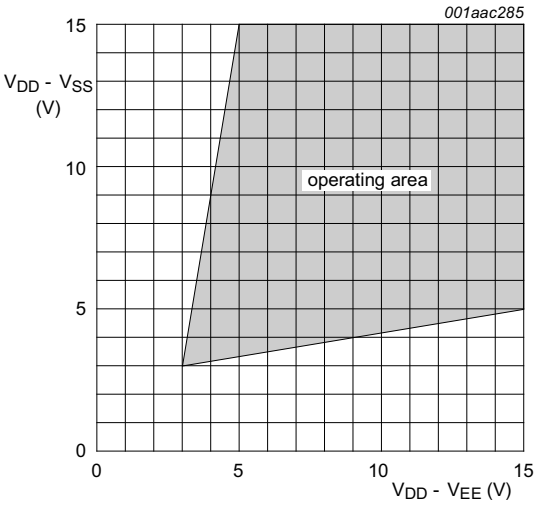


Fig 7. Operating area as a function of the supply voltages

10. Static characteristics

Table 6. Static characteristics

V_{SS} = V_{EE} = 0 V; V_I = V_{SS} or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	T_{amb} = −40 °C		T_{amb} = 25 °C		T_{amb} = 85 °C		T_{amb} = 125 °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V_{IH}	HIGH-level input voltage	$\|I_O\|$ < 1 µA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V_{IL}	LOW-level input voltage	$\|I_O\|$ < 1 µA	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
I_I	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	µA

Table 6. Static characteristics *...continued*

V_{SS} = V_{EE} = 0 V; V_I = V_{SS} or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	T_{amb} = –40 °C		T_{amb} = 25 °C		T_{amb} = 85 °C		T_{amb} = 125 °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
$I_{S(OFF)}$	OFF-state leakage current	Z port; all channels OFF; see Figure 8	15 V	-	-	-	1000	-	-	-	-	nA
		Y port; per channel; see Figure 9	15 V	-	-	-	200	-	-	-	-	nA
I_{DD}	supply current	I_O = 0 A	5 V	-	5	-	5	-	150	-	150	µA
			10 V	-	10	-	10	-	300	-	300	µA
			15 V	-	20	-	20	-	600	-	600	µA
C_I	input capacitance	Sn, $\overline{E}$ inputs	-	-	-	-	7.5	-	-	-	-	pF

10.1 Test circuits

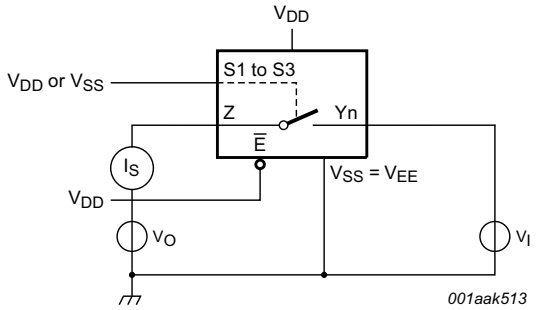


Fig 8. Test circuit for measuring OFF-state leakage current Z port

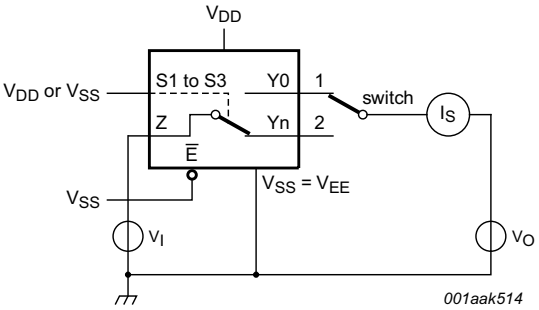


Fig 9. Test circuit for measuring OFF-state leakage current Yn port

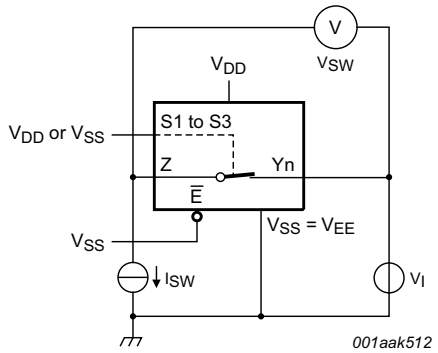
10.2 ON resistance

Table 7. ON resistance

T_{amb} = 25 °C; I_{SW} = 200 μA; V_{SS} = V_{EE} = 0 V.

Symbol	Parameter	Conditions	$V_{DD} - V_{EE}$	Typ	Max	Unit
$R_{ON(peak)}$	ON resistance (peak)	V_I = 0 V to $V_{DD} - V_{EE}$; see Figure 10 and Figure 11	5 V	350	2500	Ω
			10 V	80	245	Ω
			15 V	60	175	Ω
$R_{ON(rail)}$	ON resistance (rail)	V_I = 0 V; see Figure 10 and Figure 11	5 V	115	340	Ω
			10 V	50	160	Ω
			15 V	40	115	Ω
		V_I = $V_{DD} - V_{EE}$; see Figure 10 and Figure 11	5 V	120	365	Ω
			10 V	65	200	Ω
			15 V	50	155	Ω
ΔR_{ON}	ON resistance mismatch between channels	V_I = 0 V to $V_{DD} - V_{EE}$; see Figure 10	5 V	25	-	Ω
			10 V	10	-	Ω
			15 V	5	-	Ω

10.2.1 ON resistance waveform and test circuit



$R_{ON} = V_{SW} / I_{SW}$.

Fig 10. Test circuit for measuring R_{ON}

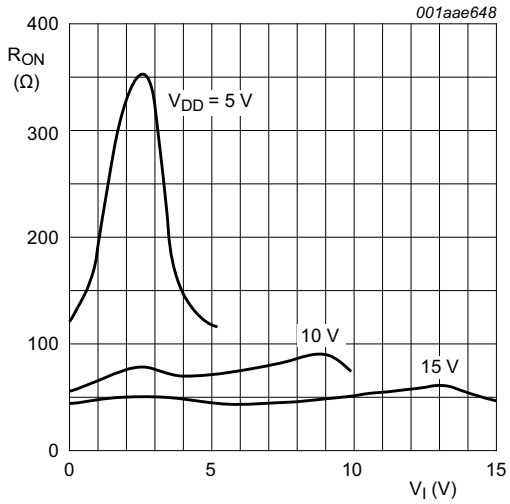


Fig 11. Typical R_{ON} as a function of input voltage

11. Dynamic characteristics

Table 8. Dynamic characteristics

T_{amb} = 25 °C; V_{SS} = V_{EE} = 0 V; for test circuit see Figure 15.

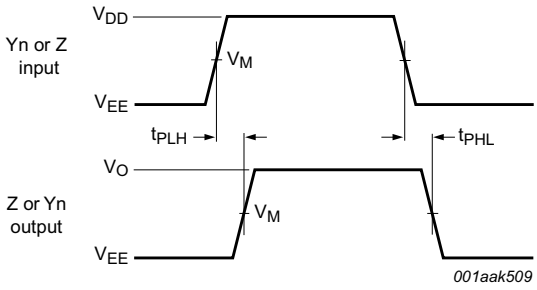
Symbol	Parameter	Conditions	V_{DD}	Typ	Max	Unit
t_{PHL}	HIGH to LOW propagation delay	Yn, Z to Z, Yn; see Figure 12	5 V	15	30	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to Yn, Z; see Figure 13	5 V	150	300	ns
			10 V	60	120	ns
			15 V	45	90	ns
t_{PLH}	LOW to HIGH propagation delay	Yn, Z to Z, Yn; see Figure 12	5 V	15	30	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to Yn, Z; see Figure 13	5 V	150	300	ns
			10 V	65	130	ns
			15 V	45	90	ns
t_{PHZ}	HIGH to OFF-state propagation delay	$\overline{E}$ to Yn, Z; see Figure 14	5 V	120	240	ns
			10 V	90	180	ns
			15 V	85	170	ns
t_{PZH}	OFF-state to HIGH propagation delay	$\overline{E}$ to Yn, Z; see Figure 14	5 V	140	280	ns
			10 V	55	110	ns
			15 V	40	80	ns
t_{PLZ}	LOW to OFF-state propagation delay	$\overline{E}$ to Yn, Z; see Figure 14	5 V	145	290	ns
			10 V	120	240	ns
			15 V	115	230	ns

Table 8. Dynamic characteristics *...continued*

T_{amb} = 25 °C; V_{SS} = V_{EE} = 0 V; for test circuit see Figure 15.

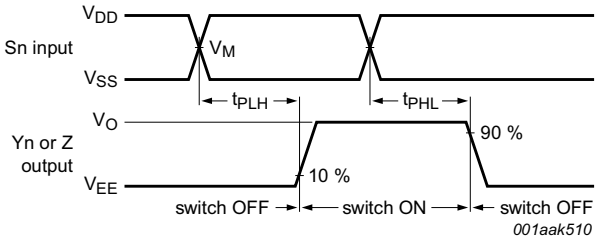
Symbol	Parameter	Conditions	V_{DD}	Typ	Max	Unit
t_{PZL}	OFF-state to LOW propagation delay	$\overline{E}$ to Yn, Z; see Figure 14	5 V	140	280	ns
			10 V	55	110	ns
			15 V	40	80	ns

11.1 Waveforms and test circuit



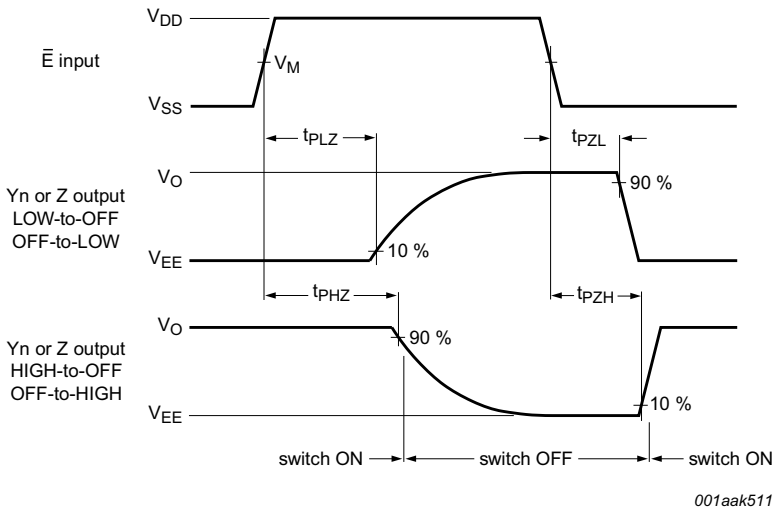
Measurement points are given in Table 9.

Fig 12. Yn, Z to Z, Yn propagation delays



Measurement points are given in Table 9.

Fig 13. Sn to Yn, Z propagation delays

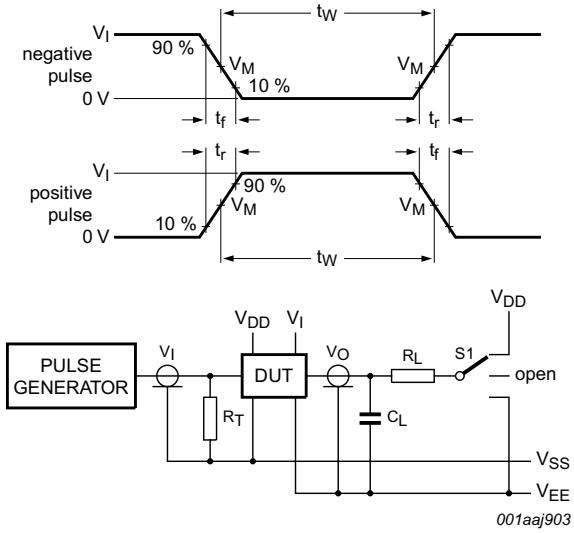


Measurement points are given in Table 9.

Fig 14. Enable and disable times

Table 9. Measurement points

Supply voltage	Input	Output
V_{DD}	V_M	V_M
5 V to 15 V	$0.5V_{DD}$	$0.5V_{DD}$



Test data is given in Table 10.

Definitions:

DUT = Device Under Test.

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

C_L = Load capacitance including test jig and probe.

R_L = Load resistance.

Fig 15. Test circuit for measuring switching times

Table 10. Test data

Input				Load		S1 position				
Yn, Z	**Sn and $\overline{E}$**	**t_r, t_f**	**V_M**	**C_L**	**R_L**	**t_{PHL}[1]**	**t_{PLH}**	**t_{PZH}, t_{PHZ}**	**t_{PZL}, t_{PLZ}**	**other**
V_{DD} or V_{EE}	V_{DD} or V_{SS}	≤ 20 ns	0.5V_{DD}	50 pF	10 kΩ	V_{DD} or V_{EE}	V_{EE}	V_{EE}	V_{DD}	V_{EE}

[1] For Yn to Z or Z to Yn propagation delays use V_{EE}. For Sn to Yn or Z propagation delays use V_{DD}.

11.2 Additional dynamic parameters

Table 11. Additional dynamic characteristics

V_{SS} = V_{EE} = 0 V; T_{amb} = 25 °C.

Symbol	Parameter	Conditions	V_{DD}		Typ	Max	Unit
THD	total harmonic distortion	see Figure 16; R_L = 10 kΩ; C_L = 15 pF; channel ON; V_I = 0.5V_{DD} (p-p); f_i = 1 kHz	5 V	[1]	0.25	-	%
			10 V	[1]	0.04	-	%
			15 V	[1]	0.04	-	%
$f_{(-3dB)}$	−3 dB frequency response	see Figure 17; R_L = 1 kΩ; C_L = 5 pF; channel ON; V_I = 0.5V_{DD} (p-p)	5 V	[1]	13	-	MHz
			10 V	[1]	40	-	MHz
			15 V	[1]	70	-	MHz
α_{iso}	isolation (OFF-state)	see Figure 18; f_i = 1 MHz; R_L = 1 kΩ; C_L = 5 pF; channel OFF; V_I = 0.5V_{DD} (p-p)	10 V	[1]	−50	-	dB
V_{ct}	crosstalk voltage	digital inputs to switch; see Figure 19; R_L = 10 kΩ; C_L = 15 pF; $\overline{E}$ or Sn = V_{DD} (square-wave)	10 V		50	-	mV
Xtalk	crosstalk	between switches; see Figure 20; f_i = 1 MHz; R_L = 1 kΩ; V_I = 0.5V_{DD} (p-p)	10 V	[1]	−50	-	dB

[1] f_i is biased at 0.5 V_{DD}; V_I = 0.5V_{DD} (p-p).

Table 12. Dynamic power dissipation P_D

P_D can be calculated from the formulas shown; V_{EE} = V_{SS} = 0 V; t_r = $t_f \leq$ 20 ns; T_{amb} = 25 °C.

Symbol	Parameter	V_{DD}	Typical formula for P_D (µW)	where:
P_D	dynamic power dissipation	5 V	$P_D = 1000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = output load capacitance in pF; V_{DD} = supply voltage in V; $\Sigma(C_L \times f_o)$ = sum of the outputs.
		10 V	$P_D = 5500 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	
		15 V	$P_D = 15000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	

11.2.1 Test circuits

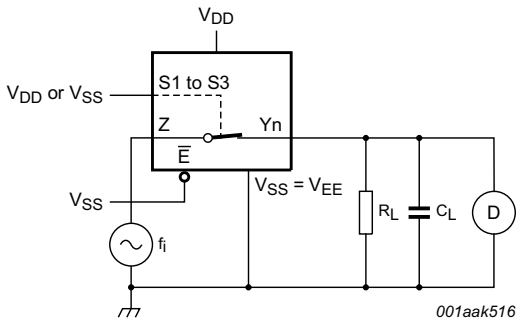


Fig 16. Test circuit for measuring total harmonic distortion

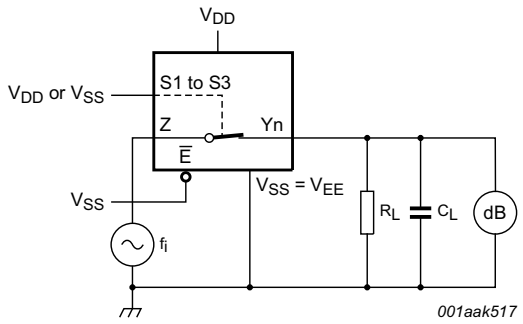


Fig 17. Test circuit for measuring frequency response

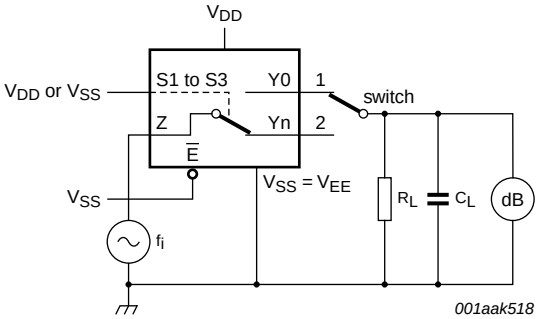
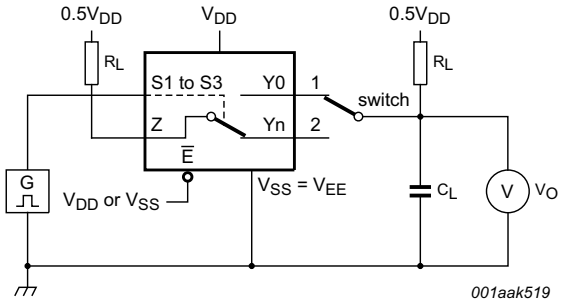
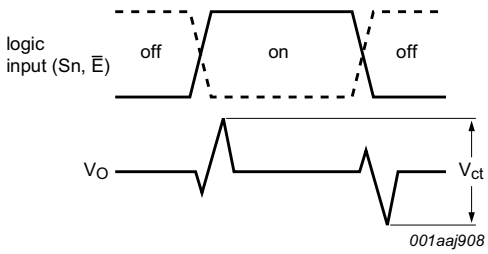


Fig 18. Test circuit for measuring isolation (OFF-state)

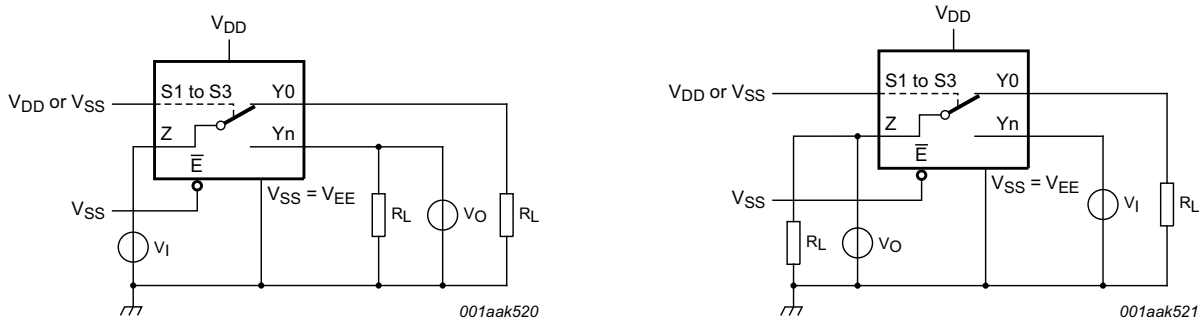


a. Test circuit



b. Input and output pulse definitions

Fig 19. Test circuit for measuring crosstalk voltage between digital inputs and switch



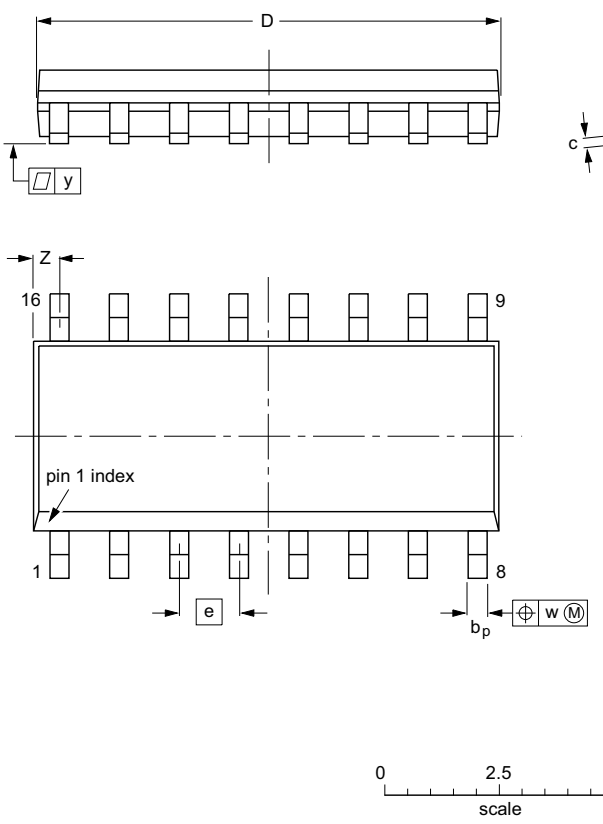
a. Switch closed condition

b. Switch open condition

Fig 20. Test circuit for measuring crosstalk between switches

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm **SOT109-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8^o 0^o
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

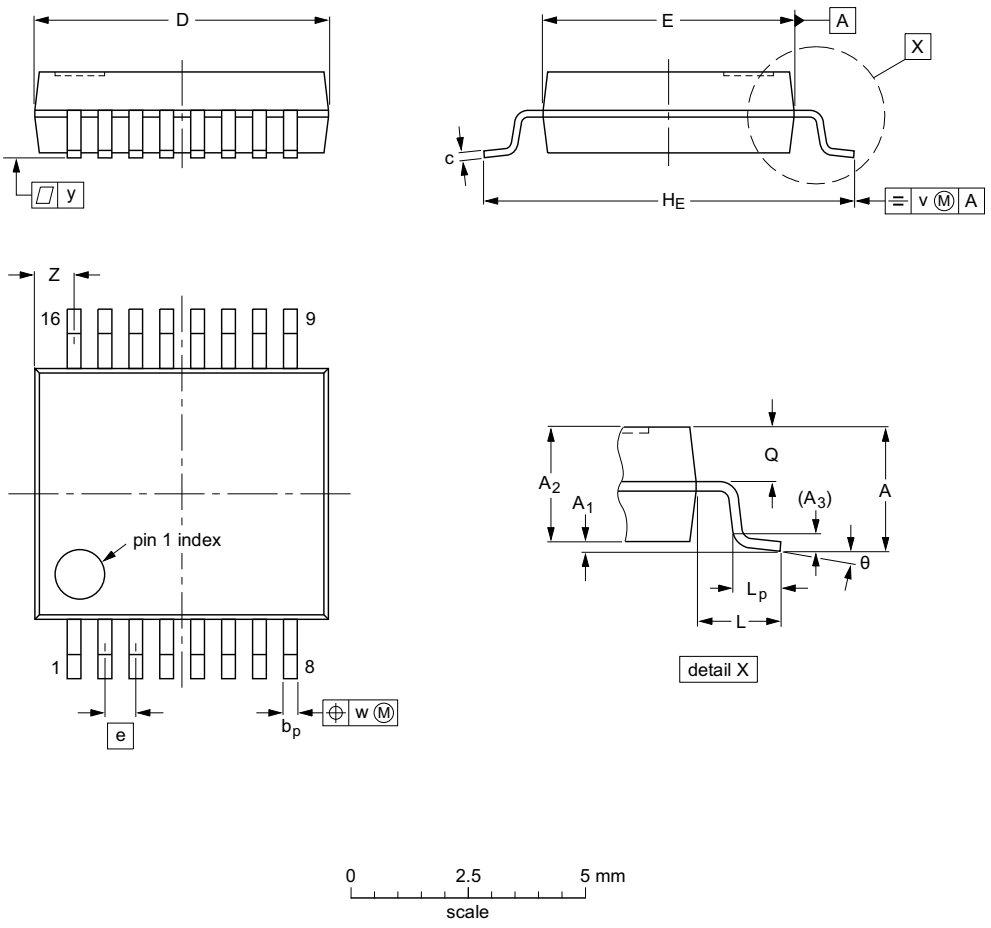
Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT109-1	076E07	MS-012				~~99-12-27~~ 03-02-19

Fig 21. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm **SOT338-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (1)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

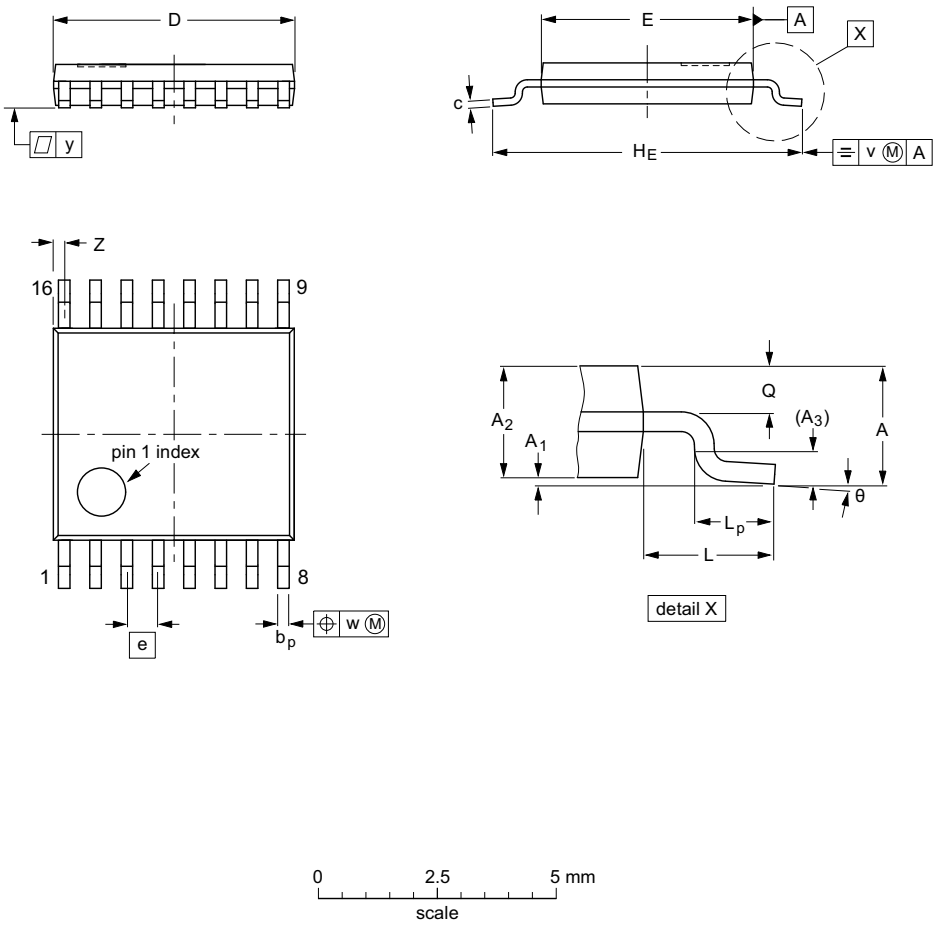
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT338-1		MO-150				~~99-12-27~~ 03-02-19

Fig 22. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm **SOT403-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (2)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT403-1		MO-153				~~99-12-27~~ 03-02-18

Fig 23. Package outline SOT403-1 (TSSOP16)

13. Abbreviations

Table 13. Abbreviations

Acronym	Description
DUT	Device Under Test

14. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4051B v.12	20160325	Product data sheet	-	HEF4051B v.11
Modifications:	• Type number HEF4051BP (SOT38-4) removed.			
HEF4051B v.11	20140911	Product data sheet	-	HEF4051B v.10
Modifications:	• Figure 19: Test circuit modified			
HEF4051B v.10	20111117	Product data sheet	-	HEF4051B v.9
Modifications:	• Legal pages updated. • Changes in “General description”, “Features and benefits” and “Applications”.			
HEF4051B v.9	20100325	Product data sheet	-	HEF4051B v.8
HEF4051B v.8	20100301	Product data sheet	-	HEF4051B v.7
HEF4051B v.7	20091127	Product data sheet	-	HEF4051B v.6
HEF4051B v.6	20090924	Product data sheet	-	HEF4051B v.5
HEF4051B v.5	20090826	Product data sheet	-	HEF4051B v.4
HEF4051B v.4	20050112	Product data sheet	-	HEF4051B_CNV v.3
HEF4051B_CNV v.3	19950101	Product specification	-	HEF4051B_CNV v.2
HEF4051B_CNV v.2	19950101	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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17. Contents

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Date of release: 25 March 2016